

SUPER FAST DIODE MODULE TYPE 600A
Features

High Surge Capability
 Type 1200V V_{RRM}
 Isolation Type Package
 Electrically Isolation base plate

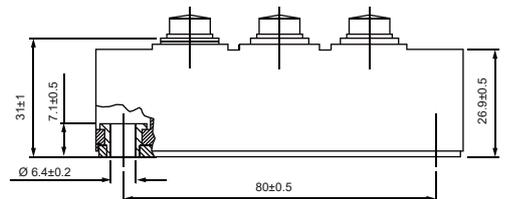
HEAVY THREE TOWER KA

Maximum Ratings

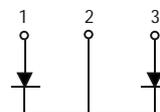
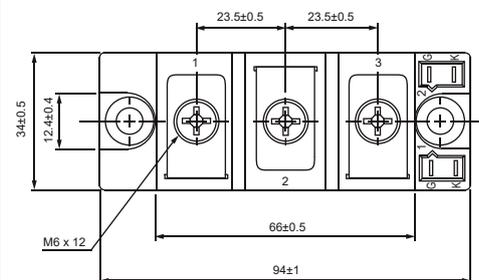
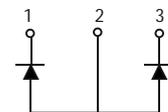
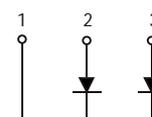
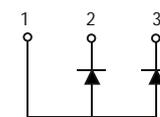
Operating Temperature : -55°C to $+175^{\circ}\text{C}$
 Storage Temperature : -55°C to $+175^{\circ}\text{C}$

Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
MURKA600120(A)(R)	1200V	840V	1200V

Dimensions in mm (1 mm = 0.0394")


Electrical Characteristics @ 25 °C Unless Otherwise Specified

Average Forward Current (Per pkg)	$I_{F(AV)}$	600A	$T_c = 100^{\circ}\text{C}$
Peak Forward Surge Current (Per diode)	I_{FSM}	6000A	8.3ms , half sine
Maximum Instantaneous Forward Voltage * (Per diode)	V_F	2.35V	$I_{FM} = 300\text{A}; T_J = 25^{\circ}\text{C}$
Maximum Instantaneous Reverse Current At Rated DC Blocking Voltage* (Per diode)	I_R	50 μA 6 mA	$T_J = 25^{\circ}\text{C}$ $T_J = 125^{\circ}\text{C}$
Maximum Reverse Recovery Time (Per diode)	T_{rr}	250ns	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{RR} = 0.25\text{A}$
Isolation Voltage	V_{isol}	3000V	A.C. 1minute
Maximum Thermal Resistance Junction To Case	$R_{\theta jc}$	0.14 $^{\circ}\text{C}/\text{W}$ 0.28 $^{\circ}\text{C}/\text{W}$	Per pkg Per diode
Mounting torque	M_d	2.5 \pm 0.5Nm 4.5 \pm 0.5Nm	To heatsink To terminal


 Common Cathode
 MURKA600120

 Common Anode
 MURKA600120R

 Common Cathode
 MURKA600120A

 Common Anode
 MURKA600120AR

*Pulse Test: Pulse Width 300 μsec , Duty Cycle < 2%

Figure .1- Typical Forward Characteristics

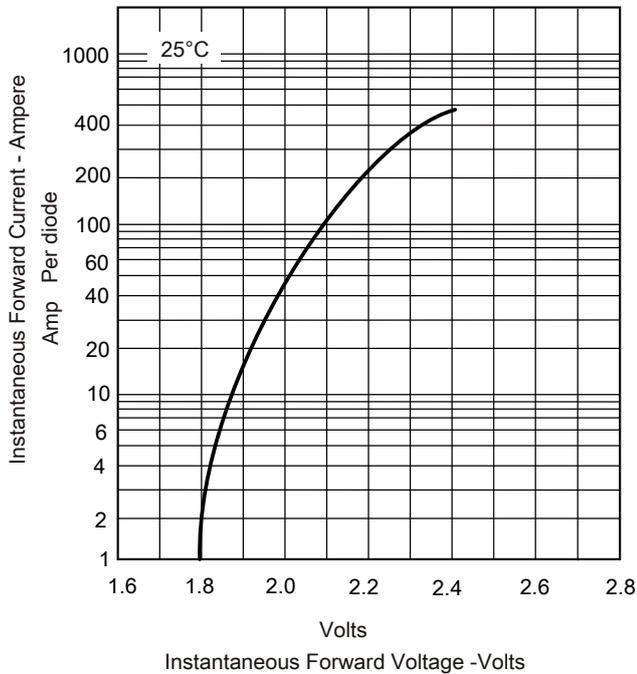


Figure .2-Forward Derating Curve

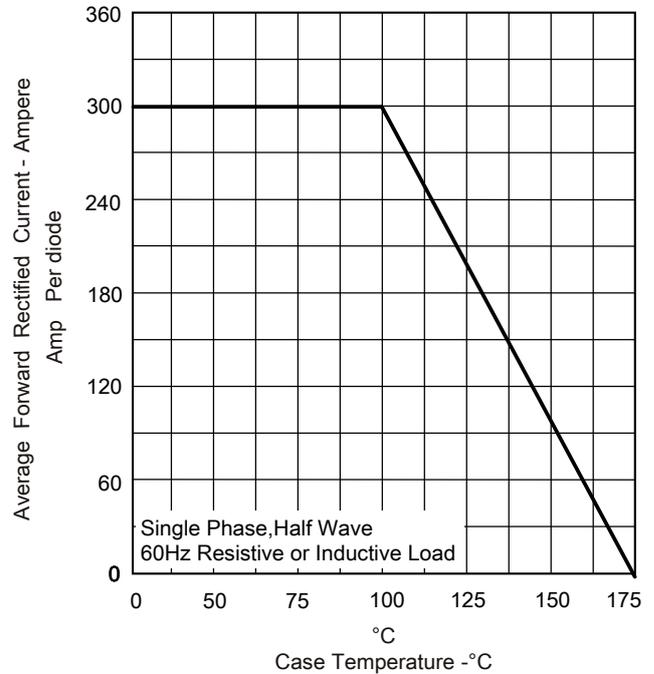


Figure .3-Peak Forward Surge Current

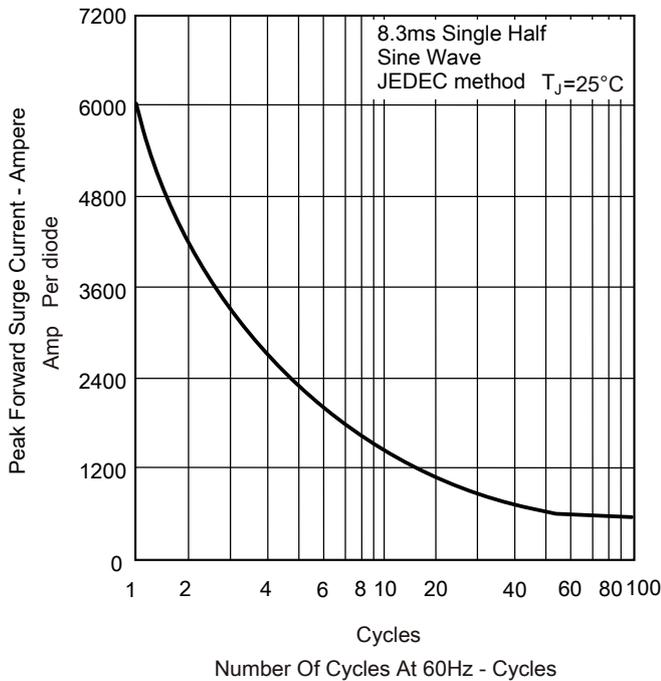
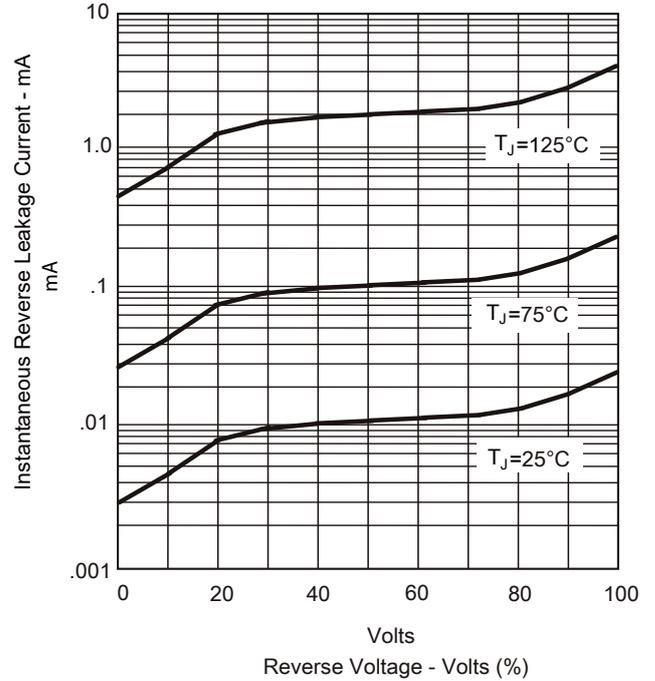


Figure .4-Typical Reverse Characteristics



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